

Features

- Excellent thermal conductivity
- Excellent insulating ability
- Excellent DimensionalStability
- Excellent MechanicalStrength
- Lower heat expansibility
- Lower operating temperature
- Increase power density
- Reduce the number of interconnects
- Extend the life of dies

OP REBEL STAR

OP REBEL STAR
ALUMINUM CLAD PRINTED
CIRCUIT BOARD FOR
LUXEON REBEL ALLOWS
OPTIMUM HEAT
DISSIPATION.





This is a custom MCPCB structure that further enhances heat dissipation and thus enabling the LED to last according to its life time.

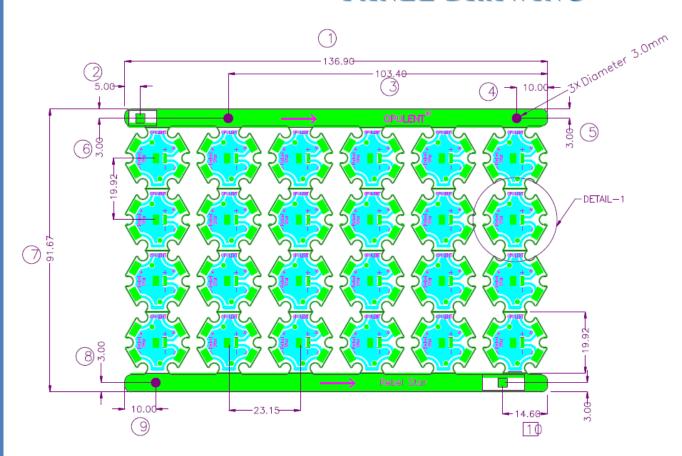
Higher thermal conductive MCPCB is also available with our special enhanced capabilities.

CONSTRUCTION OF MCPCB

The structure of the aluminum material includes copper layer, dielectric layer laminated together with aluminum base layer. Below appends summary of available range of material:

Aluminum	Aluminum	Copper	Dielectric
Type	Thickness	Thickness	Thickness
AL 5052	1.5 mm	1 oz	0.100mm

PANEL DRAWING



MATERIAL DATASHEET

Material Datasheet - OPT111.01.Al5215.4.0018 **Treatment** Value Unit Condition Thermal Properties Thermal Conductivity 1.8 W/m-k (Dielectric layer) Thermal Resistance °C-in²/W 0.086 (Dielectric layer) **Maximum Operating Temperature UL 746** 125 $^{\circ}C$ °C Glass Transition Temp (Tg) DSC 130 21.5 < Tg x10⁻⁶/°C Coefficient of Thermal Expansion (CTE) > Tg 22.0 **Electrical Properties** 4.2 Dielectric constant 1kHz/1MHz **Dissipation Factor** 1kHz/1MHz 0.02 1×10⁸ Volume Resistivity C-96/40/90 $M\Omega \cdot cm$ **Surface Resistivity** C-96/40/90 1×10⁷ МΩ Dielectric Breakdown Voltage Α 30 KV/mm **Mechanical Properties** Dielectric Thickness Α 100 μm Peel Strength Α 1.05 N/mm **Chemical Properties** D-24/23 0.09 % Water absorption **Ratings and Durability UL Flammablility** 94 V-0 Comparative Tracking Index IEC60112 600 10 sec @ 288 °C, Thermal stress Pass 3 cycles Time to delamination 5min @ 260 °C Pass

^{*} The data is based on typical values of standard production and should be considered as general information. Our company reserves the right for future changes. It is the responsibility of the user to ensure that the product complies with his requirements.



PRODUCT SPECIFICATIONS

OP REBEL STAR MCPCB

Aluminum Type: AL5052

Aluminum Thickness: 1.5mm

Copper Thickness: 1oz

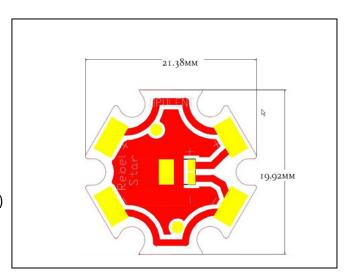
Dielectric Thickness: 0.1mm

Unit Size: 21.38 x 19.92mm (±0.1mm)

Panel Size: 136.9 x 91.67mm (24pcs/pnl)

Finishing: OSP

Solder Mask: Glossy Black



SOLDER PASTE

Type: Leadfree SAC 305 paste, grade 3 or above

Lumileds Internal: Alpha Metal OM325 grade 4

Alternative: Alpha Metal OM338 grade 3

PACKAGING

One carton consists of 10 internal white boxes. Each white box consists of 3 trays. Each tray consists of 48 pieces.

Type of tray: Individual slot for each OP Rebel Star

Cavity per tray: 48 pcs

Dimension of tray: 44.3cm x 17.25cm x 2.3cm

Internal White Box: contains 3 trays with 1 cover tray (equivalent to 144pcs of OP Rebel)

Dimension of I.W.B: 44.8cm x 17.7cm x 5.5cm

Carton box: contains 10 white boxes (equivalent to 1440pcs of OP Rebel Star)

Dimension of carton: 45.5cm x 36.4cm x 28.5cm



ABOUT OPULENT

Opulent (Asia)

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eadquartered in Singapore, Opulent has more than 20 years experience in the manufacturing of conventional printed circuit boards (PCBs). Embarking for an international presence, Opulent has set up sales and marketing support in China, Hong Kong, Germany, Italy, United Kingdom and Malaysia.

Through innovation and R&D, Opulent created metal-clad PCBs (MCPCB) and is currently a leading designer and manufacturer of thermal solutions. Our products and works are guided by a customer centric approach that empowers us to provide value added solutions from design to assembly.

Our customers are well-known international brands whom have come to trust Opulent for our innovation, our knowledge and our commitment to attain customer satisfaction.

